

	Hits	Search Text	DBs	Time Stamp
1	1964	(isotropic omnidirectional)adj(dip etch wash)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 17:52
2	825	((isotropic omnidirectional)adj(dip etch wash)) and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/01/10 14:39
3	221	((((isotropic omnidirectional)adj(dip etch wash)) and electrode) and dram	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 17:53
4	22	(((((isotropic omnidirectional)adj(dip etch wash)) and electrode) and dram) and japanese	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 19:47
5	22	(((((isotropic omnidirectional)adj(dip etch wash)) and electrode) and dram) and japanese	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 19:37
6	199	(((((isotropic omnidirectional)adj(dip etch wash)) and electrode) and dram) not japanese	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 21:26
7	1169	("257/306,309").CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/01/10 14:40
8	162	((("257/306,309").CCLS.) and grain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 20:37
9	89	((("257/306,309").CCLS.) and grain) and grain with capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/06/14 21:59
10	927	((isotropic omnidirectional)adj(dip etch wash)) and electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/01/10 14:43
11	1595	("257/306,309,296").CCLS.	USPAT	2002/01/10 14:43